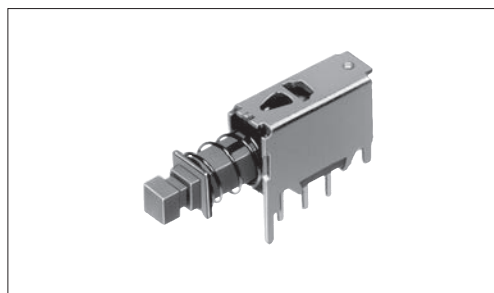


SPPJ3 2.5mm-travel Compact-sized Horizontal Type

Lever height 4.7mm, small sized horizontal type



Typical Specifications



Items		Specifications
Rating (max.)/(min.) (Resistive load)		0.2A 30V DC / 50μA 3V DC
Contact resistance (Initial/After operating life)		20mΩ max. / 40mΩ max.
Operating force	1-pole	2.3±1N
	2-pole	3.3±1N
Operating life	Without load	10,000 cycles
	With load	10,000 cycles (0.2A 30V DC)

Product Line

Changeover timing	Travel (mm)	Total travel (mm)	Mounting method	Poles	Operation	Terminal type	Minimum order unit (pcs.)		Product No.	Drawing No.
							Japan	Export		
Non shorting	2.5	3.5	PC board	1	Latching	For PC board	100	4,500	SPPJ310500	1
					Momentary				SPPJ311500	
				2	Latching				SPPJ320600	2
					Momentary				SPPJ322300	

Packing Specifications

Bulk

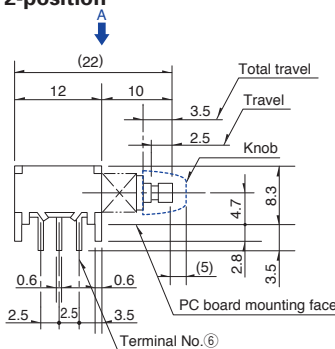
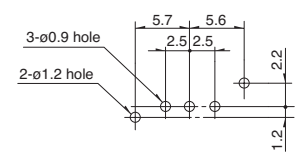
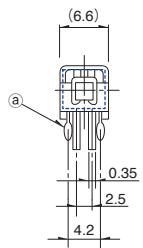
Number of packages (pcs.)		Export package measurements (mm)
1 case / Japan	1 case / export packing	
900	4,500	400×270×290

Dimensions

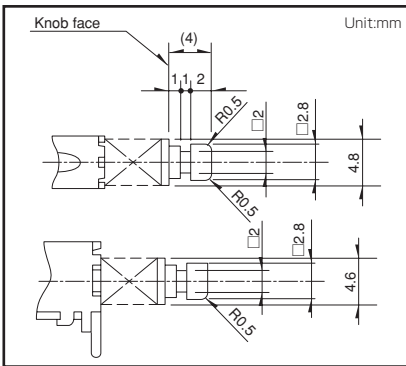
Unit:mm

No.	Style	PC board mounting hole dimensions (Viewed from the direction A)
1	1-pole, 2-position	

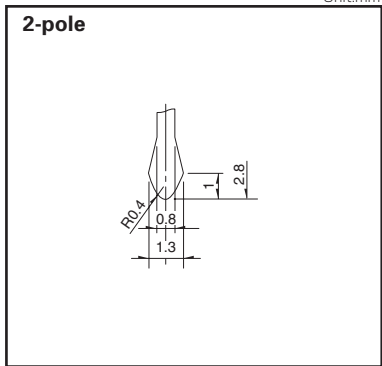
■ Dimensions

No.		Style	PC board mounting hole dimensions (Viewed from the direction A)
2		2-pole, 2-position 	
			

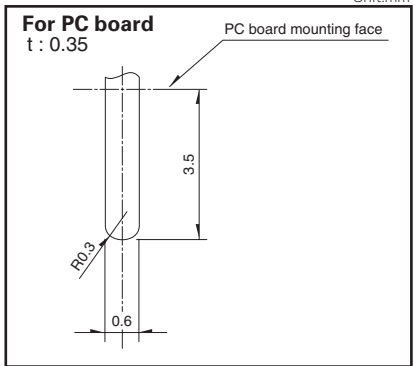
■ Actuator Configuration at Front Edge



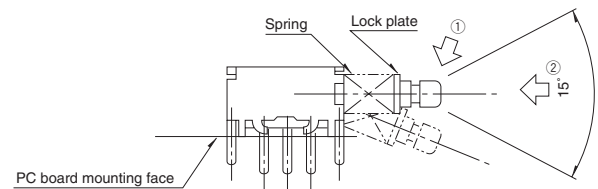
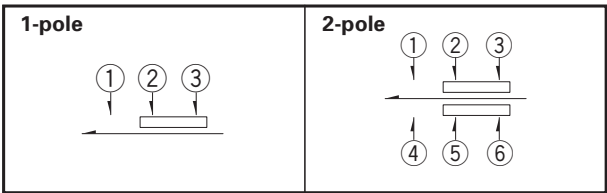
■ Detail of ①



■ Terminal Configuration



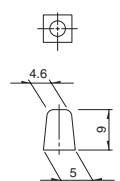
■ Circuit Diagram (Viewed from Direction A)



■ Note

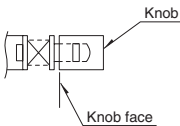
The SPPJ3 series should be operated in arrow 2 direction as shown in the following figure and applied within an angle of 15° based from the center. If excessive force is applied to the lever from arrow ① direction, it may fall down as illustrated and cause malfunctions.

■ Attached Parts

Knob outline drawing		Model
		UJ206022

■ Notes

1. Other knob varieties are also available. Please inquire.
2. We recommend the use of adhesive to secure the knob when mounting onto switches.



Push Switches

List of Varieties

Series			Horizontal				
			SPPJ3	SPPJ2	SPUJ※	SPUN	SPUN medium current ※
Photo							
Dimensions (mm)	W	5 or 6.6		7.2	7.5	10	
	D	12			15.2 22.7	24 36	
	H	8.3	9.6		8.8	13	
Travel (mm)			2.5			2	2.5
Total travel (mm)			3.5			3	3.5
Number of poles			1 2	2	2 4		
Operating temperature range			−40℃ to +85℃		−10℃ to +60℃		
Automotive use			●	●	—	—	—
Life cycle							
Rating (max.) (Resistive load)			0.2A 30V DC			0.1A 30V DC	
Rating (min.) (Resistive load)			50μA 3V DC				1A 25V DC
Durability	Operating life without load		10,000 cycles 40mΩ max.				30,000 cycles 40mΩ max.
	Operating life with load (at max. rated load)		10,000 cycles 40mΩ max.				5,000 cycles 40mΩ max.
Electrical performance	Initial contact resistance		20mΩ max.				
	Insulation resistance		100MΩ min. 500V DC				
	Voltage proof		500V AC for 1minute				
Mechanical performance	Terminal strength		5N for 1minute				
	Actuator strength	Operating direction	50N	30N	50N		
		Pulling direction	—	—	50N		
Environmental performance	Cold		−40℃ 96h	−20℃ 96h			
	Dry heat		85℃ 96h				
	Damp heat		40℃, 90 to 95%RH 96h				
Page			116	118	120	122	

Push Switches Soldering Conditions 138
Push Switches Cautions 139

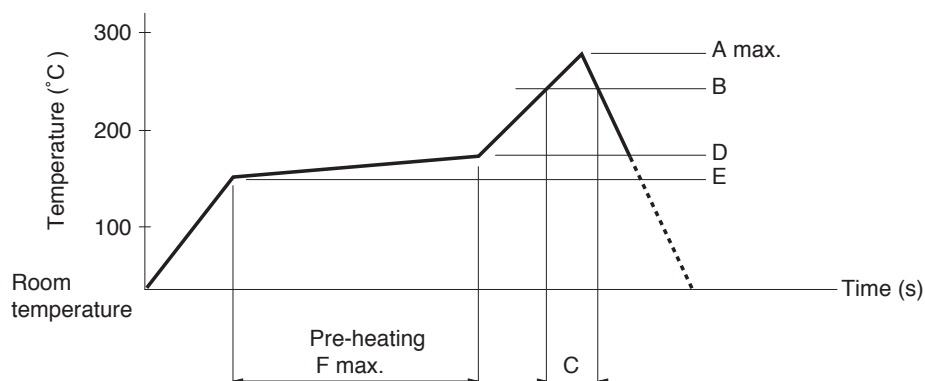
Notes

- ※ The operating temperature range for automotive applications can be raised upon request. Please contact us for details.
- Indicates applicability to all products in the series.

Push Switches Soldering Conditions

Example of Reflow Soldering Condition

1. Heating method: Double heating method with infrared heater.
2. Temperature measurement: Thermocouple ϕ 0.1 to 0.2 CA (K) or CC (T) at soldering portion (copper foil surface).
A heat resisting tape should be used for fixed measurement.
3. Temperature profile



Series (Reflow type)	A (°C) 3s max.	B (°C)	C (s)	D (°C)	E (°C)	F (s)
SPEG	260	230	40	180	150	120
SPEJ						
SPEF						
SPEH						

Notes

1. The condition mentioned above is the temperature on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the PC board's material, size, thickness, etc.
The above-stated conditions shall also apply to switch surface temperatures.
2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Reference for Hand Soldering

Series	Soldering temperature	Soldering time
SPPJ3, SPPJ2, SPUN, SPPH4, SPPH1	350±10°C	3+1/0s
SPED2, SPED4	350±10°C	3±0.5s
SPEJ	350±10°C	4s max.
SPEG, SPEF	350±5°C	3s max.
SPEH, SPPH2	350°C max.	3s max.
SPUJ	300±10°C	3+1/0s

Reference for Dip Soldering

(For PC board terminal types)

Series	Items		Dip soldering	
	Preheating temperature	Preheating time	Soldering temperature	Duration of immersion
SPPJ3	100°C max.	60s max.	260±5°C	5±1s
SPUN	100°C max.	60s max.	260±5°C	10±1s
SPUJ, SPPH2, SPPH4	—		260±5°C	5±1s
SPPJ2, SPPH1, SPED2, SPED4, SPEF	—		260±5°C	10±1s